

# TO-3216BY-MWG

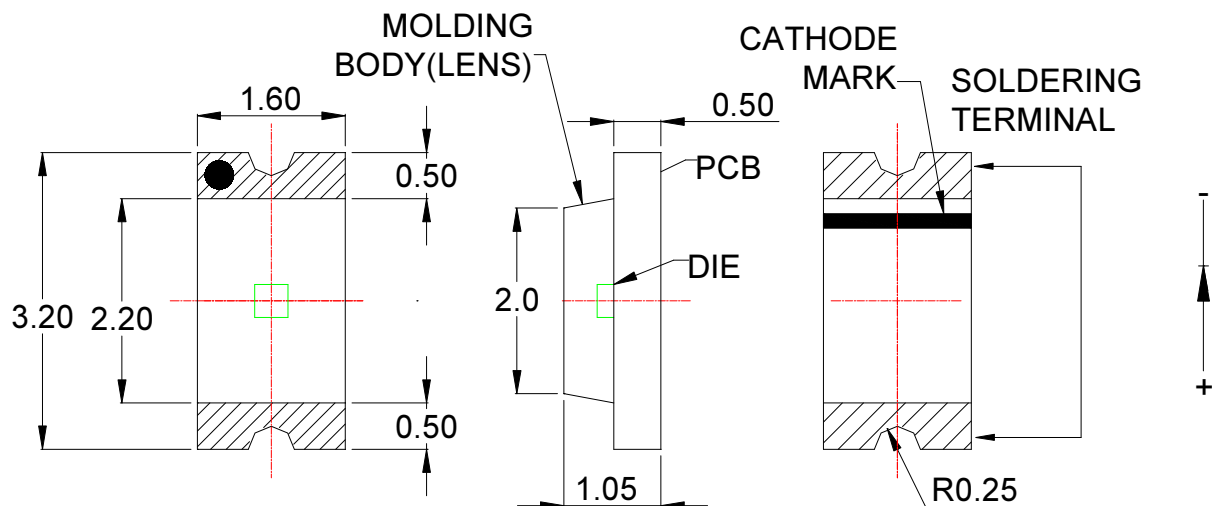
## Surface Mount Device LED

Part Number	Chip		Lens Color
	Material	Source Color	
TO-3216BY-MWG	InGaN	Ultra White	Yellow Diffused

### Features

- IC compatible
- Compatible with automatic placement equipment
- Compatible with infrared and vapor phase reflow solder process
- Top view type
- Package in 8 mm tape on 7" diameter reel
- RoHS compliant
- Moisture sensitivity level: level 3

### Dimensions



#### Notes:

1. All dimensions are in millimeters.
2. Tolerance is  $\pm 0.1$ mm unless otherwise noted.

### Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA
Power Dissipation	105	mW
Continuous Forward Current	25	mA
Reverse Voltage	5	V
Operating Temperature Range	-55°C to +85°C	
Storage Temperature Range	-55°C to +105°C	
IR Reflow Soldering Profile For Lead Free Soldering	260°C	

### Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I <sub>v</sub>	321		917	mcd	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		160		deg	I <sub>F</sub> =20mA
Forward Voltage	V <sub>F</sub>		3.3		V	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>			10	μA	V <sub>R</sub> =5V
Color Temperature	T <sub>c</sub>		6000		K	I <sub>F</sub> =20mA
Chromaticity Coordinates	X		0.325			I <sub>F</sub> =20mA
Chromaticity Coordinates	Y		0.34			I <sub>F</sub> =20mA